

Single P-channel MOSFET

ELM4PB3103FNA-N

<https://www.elm-tech.com>

■General description

ELM4PB3103FNA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate threshold voltage.

■Features

- $V_{ds}=-30V$
- $I_d=32A (V_{gs}=-10V)$
- $R_{ds(on)}=20m\Omega (V_{gs}=-10V)$
- $R_{ds(on)}=32m\Omega (V_{gs}=-4.5V)$

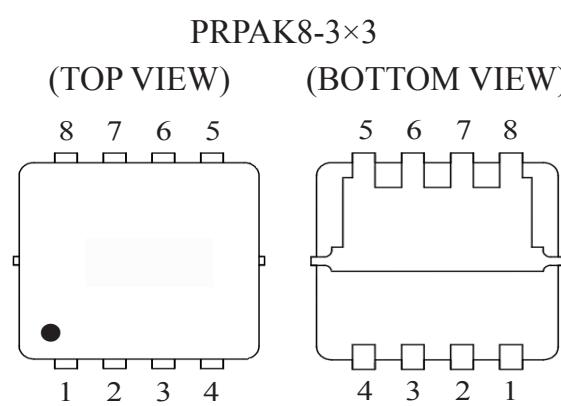
■Maximum absolute ratings

Parameter	Symbol	Limit		Unit	Note
		10s	Steady state		
Drain-source voltage	V_{ds}	-	-30	V	
Gate-source voltage	V_{gs}	-	± 25	V	
Continuous drain current ($V_{gs}=-10V$)	$T_c=25^\circ C$	I_d	-32	A	1
	$T_c=100^\circ C$		-20		
	$T_a=25^\circ C$	I_d	-12.2		
	$T_a=70^\circ C$	I_d	-9.8		
Pulsed drain current	I_{dm}	-	-65	A	2
Single pulse avalanche energy	E_{as}	-	72.2	mJ	3
Avalanche current	I_{as}	-	-38	A	
Power dissipation	$T_c=25^\circ C$	P_d	29.00	W	4
	$T_a=25^\circ C$		4.20		
Junction and storage temperature range	T_j, T_{stg}	-	-55 to +150	°C	

■Thermal characteristics

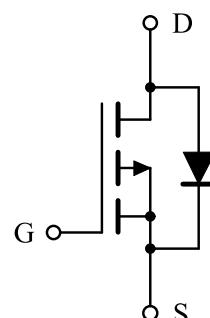
Parameter	Symbol	Typ.	Max.	Unit	Note
Thermal resistance junction-to-ambient	$R_{\theta ja}$	-	75	°C/W	1
Thermal resistance junction-to-ambient ($t \leq 10s$)		-	30		
Thermal Resistance Junction-Case	$R_{\theta jc}$	-	4.32	°C/W	1

■Pin configuration



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

■Circuit



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■Electrical characteristics

T_j=25°C. Unless otherwise noted.

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	V _{gs} =0V, I _d =-250μA	-30	-	-	V	
Zero gate voltage drain current	Id _{ss}	V _{ds} =-24V, V _{gs} =0V	-	-	-1	μA	
		V _{ds} =-24V, V _{gs} =0V, T _j =55°C	-	-	-5		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±25V	-	-	±100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250μA	-1.0	-	-2.5	V	
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V, I _d =-15A	-	-	20	mΩ	2
		V _{gs} =-4.5V, I _d =-10A	-	-	32		
Forward transconductance	G _{fs}	V _{ds} =-5V, I _d =-15A	-	19	-	S	
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V	-	-	-1.2	V	2
Max. body-diode continuous current	I _s	V _{gs} =V _{ds} =0V, Force current	-	-	-32	A	1, 5
Pulsed source current	I _{sm}		-	-	-65	A	2, 5
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-15V, f=1MHz	-	1345	-	pF	
Output capacitance	C _{oss}		-	194	-	pF	
Reverse transfer capacitance	C _{rss}		-	158	-	pF	
Gate resistance	R _g	V _{ds} =0V, V _{gs} =0V, f=1MHz	-	13	-	Ω	
SWITCHING PARAMETERS							
Total gate charge (-4.5)	Q _g	V _{gs} =-4.5V, V _{ds} =-15V I _d =-15A	-	12.5	-	nC	
Gate-source charge	Q _{gs}		-	5.4	-	nC	
Gate-drain charge	Q _{gd}		-	5.0	-	nC	
Turn-on delay time	t _{d(on)}	V _{gs} =-10V, V _{ds} =-15V I _d =-15A, R _{gen} =3.3Ω	-	4.4	-	ns	
Turn-on rise time	t _r		-	11.2	-	ns	
Turn-off delay time	t _{d(off)}		-	34.0	-	ns	
Turn-off fall time	t _f		-	18.0	-	ns	
Reverse recovery time	t _{rr}	I _f =-15A, dI/dt=100A/μs	-	12.4	-	ns	
Reverse recovery charge	Q _{rr}		-	5.0	-	nC	

NOTE :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300μs and duty cycle ≤ 2%.
3. The Eas data shows Max. rating . The test condition is V_{dd}=-25V, V_{gs}=-10V, L=0.1mH, I_{as}=-38A.
4. The power dissipation is limited by 150°C junction temperature.
5. The data is theoretically the same as I_d and I_{dm}, in real applications, should be limited by total power dissipation.

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■ Typical electrical and thermal characteristics

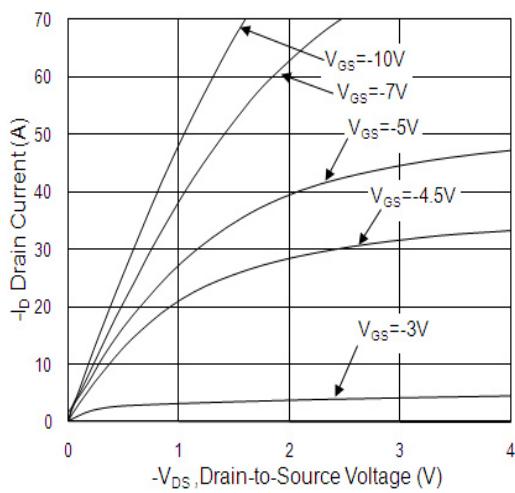


Fig.1 Typical Output Characteristics

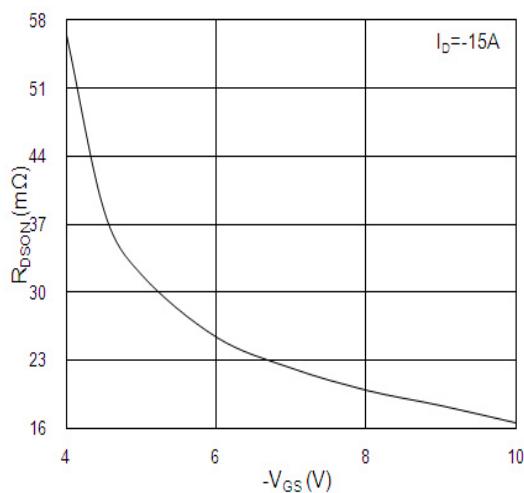


Fig.2 On-Resistance v.s Gate-Source

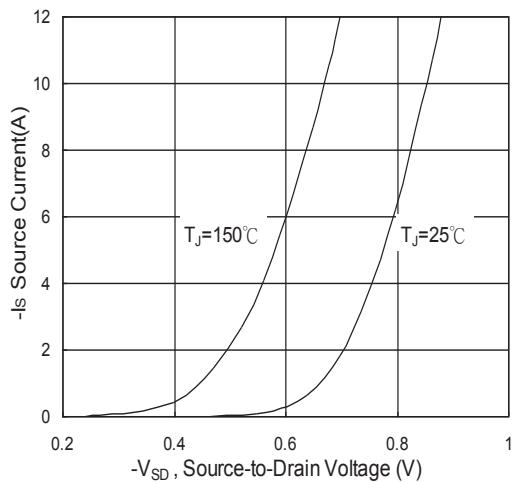


Fig.3 Forward Characteristics of Reverse

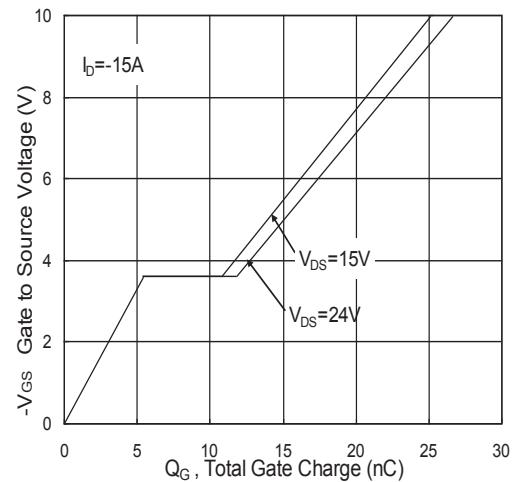


Fig.4 Gate-Charge Characteristics

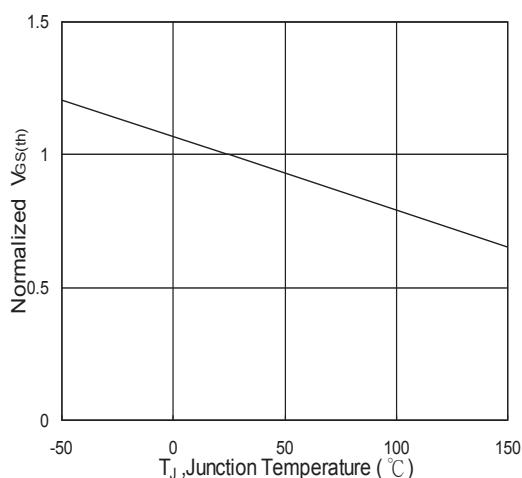


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

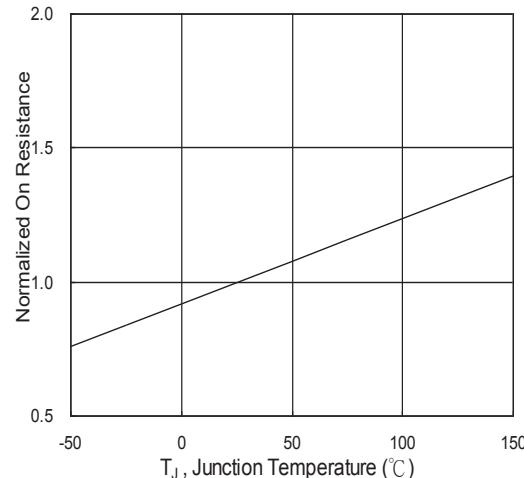


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

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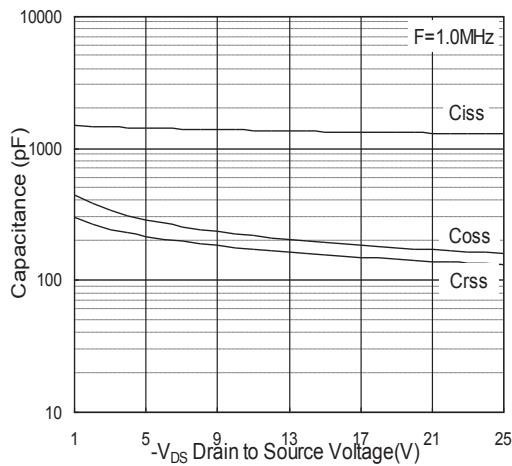


Fig.7 Capacitance

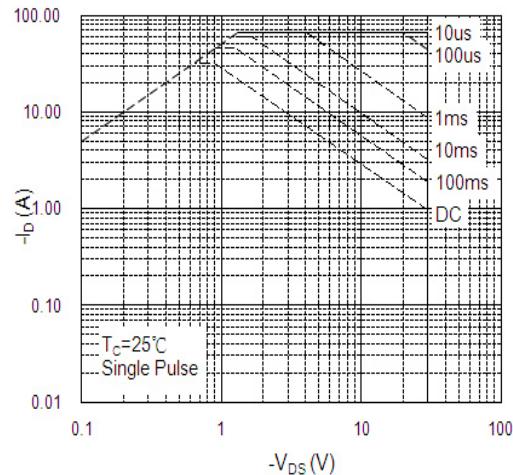


Fig.8 Safe Operating Area

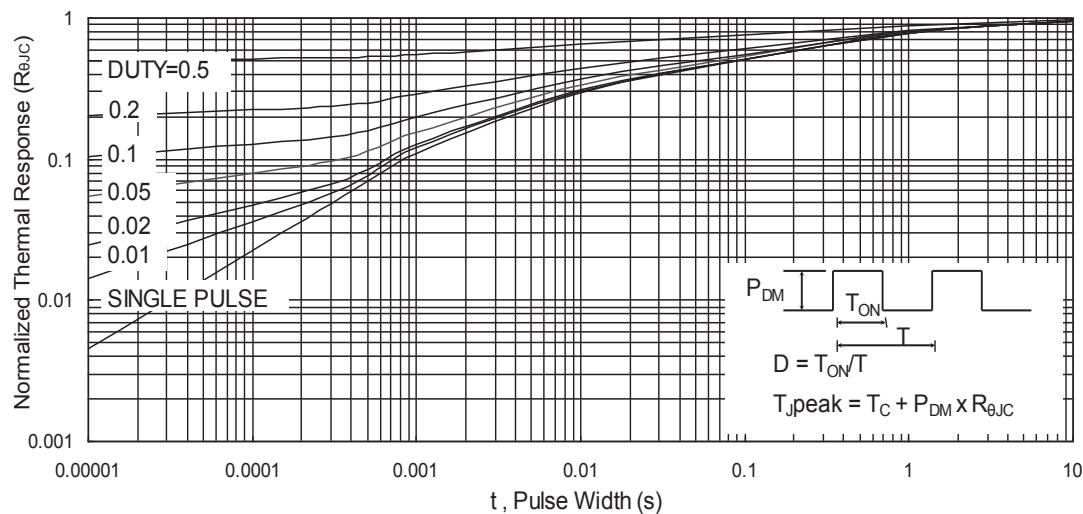


Fig.9 Normalized Maximum Transient Thermal Impedance

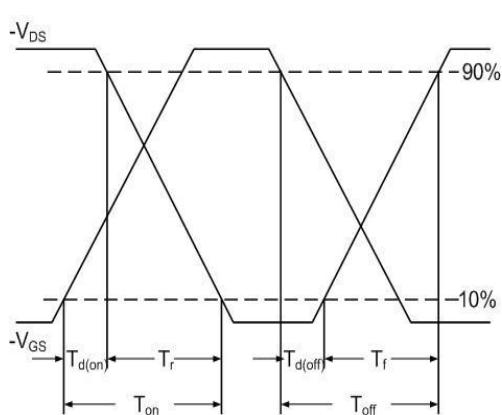


Fig.10 Switching Time Waveform

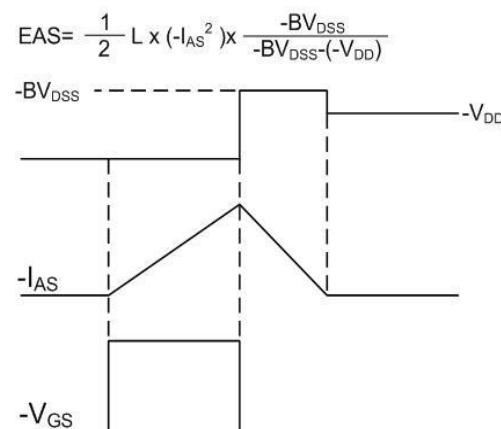


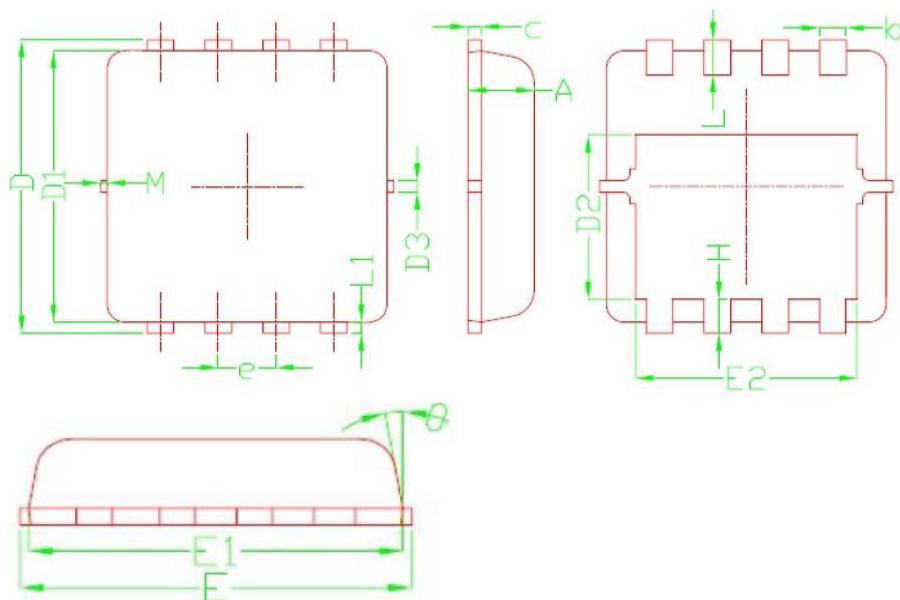
Fig.11 Unclamped Inductive Switching Waveform

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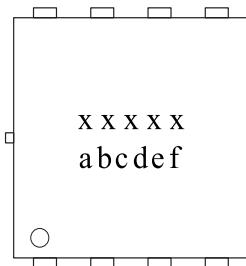
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■PRPAK8-3×3 dimension (3,000pcs/reel)



Symbols	Millimeters			Symbols	Millimeters		
	Min.	Nom.	Max.		Min.	Nom.	Max.
A	0.70	---	0.85	E1	3.00	---	3.25
b	0.20	---	0.40	E2	2.29	---	2.65
c	0.10	---	0.25	e	0.65 BSC		
D	3.15	---	3.45	H	0.28	---	0.65
D1	2.90	---	3.20	θ	0°	---	14°
D2	1.54	---	1.98	L	0.30	---	0.50
D3	0.10	0.20	0.30	L1	---	0.13	---
E	3.15	---	3.45	M	---	---	0.15

■Marking



Symbols	Content
XXXXX	Product code
a	Yearly code: 2019=K, 2020=L, 2021=M, 2022=N ...
b, c	Weekly code: 01 to 53
d, e	Sequence: 01 to 99 or 0A to 0Z
f	Assembly code: A to Z (I, O excepted)